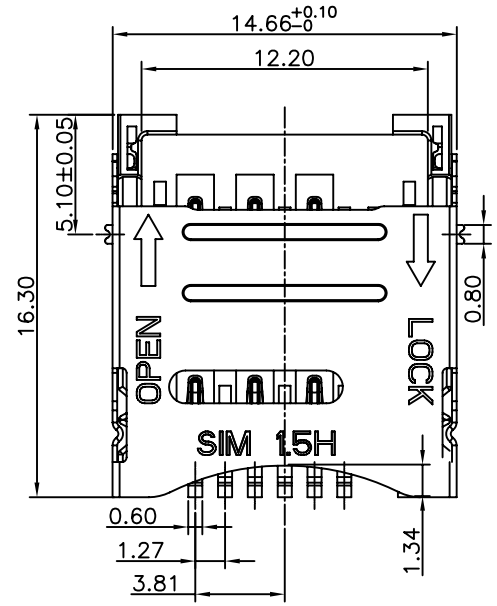
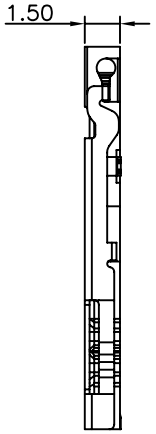
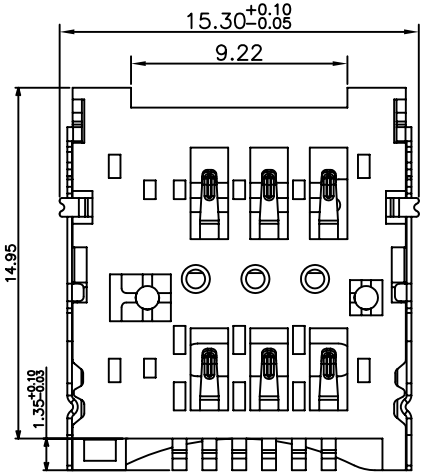
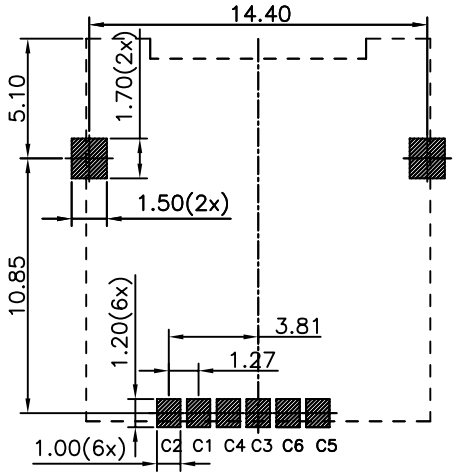
| REV. | DATE | ECN NO. | MODIFICATION | APPROVER |
|---|---|---|---|---|
| A | 2012/03/28 | / | NEW | Vicky |



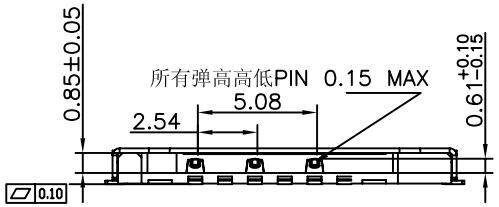

LOCK

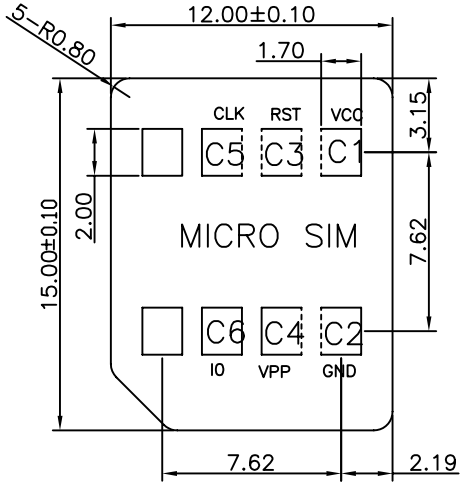


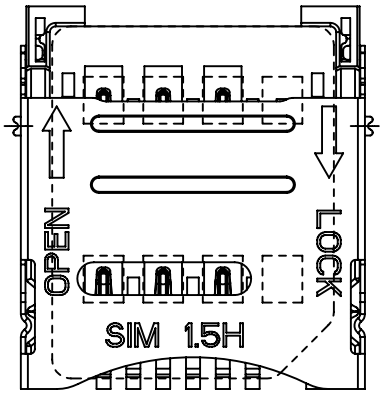




PCB LAYOUT

| PIN NO. | NAME |
|---|---|
| C1 | VCC |
| C2 | GND |
| C3 | RST |
| C4 | VPP |
| C5 | CLK |
| C6 | IO |




插卡示意图

NOTES:

1.MATERIAL:

1.1 Housing: LCP UL94V-0,Color:Black

1.2 Terminal:PHOSPHOR BRONZE,1μ″Au plating on the contact area,Matte 100μ″ Tin on the solder tails

1.3 Shell:SUS, 100μ″ Tin Plated

2.SPECIALITY:

2.1 Rated Current:1.0A

2.2 Contact Resistance:50mΩ Max

2.3 Insulation Resistance:100MΩ Min 250V DC

2.4 Dielectric Withstanding Voltage:250V AC

2.5 Solder Ability:235±5°C;5±0.5s

2.6 Durability:5000 cycles

2.7 Resistance to soldering heat Temperature 250±5°C,Time;2Minutes

2.8 Operating Condition:Temperature:-30°C~+80°C; Humidity:80%R.H Max

| GENERAL TOLERANCE | | | |
|---|---|---|---|
| SELECT | ✓ | | |
| TOL. / ON. | 1 | 2 | 3 |
| X.XXX | | ±0.05 | ±0.15 |
| X.XX | ±0.20 | ±0.13 | ±0.25 |
| X.X | ±0.30 | ±0.25 | ±0.50 |
| X. | ±0.50 | ±0.38 | ±1.00 |
| ANGLE | ±2° | | |

UNITS mm

MAT'L

FINISH

Q'TY

NAME: MICRO SIM

PART NO: SI35C-08200

APPD: Vicky

CHKD: Doris

DR: Jilian

ATOM® 深圳市爱特姆科技有限公司 SHENZHEN ATOM TECHNOLOGY CO.,LTD.

TITLE: MICRO SIM CARD 6P H=1.5mm 掀盖式

DWG NO. ATOM-A02608

| SCALE | SHEET | REV |
|---|---|---|
| 1:1 | 1/1 | A |